

Features

- 1.2kV Schottky Rectifier
- Zero Reverse Recovery Current
- High-Frequency Operation
- Temperature-Independent Switching
- Extremely Fast Switching
- Positive Temperature Coefficient on V_F
- Increased Creepage/Clearance Distance

Benefits

- Replace Bipolar with Unipolar Rectifiers
- Essentially No Switching Losses
- Higher Efficiency
- Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway

Applications

- Switch Mode Power Supplies (SMPS)
- Boost diodes in PFC or DC/DC stages
- Free Wheeling Diodes in Inverter stages
- AC/DC converters





| Part Number | Package | Marking |
|-------------|----------|------------|
| HC4D10120H | TO247-2L | HC4D10120H |

Maximum Ratings (Tc=25°C unless otherwise specified)

| Symbol | Parameter | Value | Unit | Test Conditions | Note |
|-----------------------------------|--|------------------|--------------|--|--------|
| V _{RRM} | Repetitive Peak Reverse Voltage | 1200 | V | | |
| V _{RSM} | Surge Peak Reverse Voltage | 1300 | V | | |
| V _R | DC Peak Reverse Voltage | 1200 | ٧ | | |
| I _F | Continuous Forward Current | 31.5 15 10 | А | T _c =25°C T _c =135°C T _c =155°C | Fig. 3 |
| $I_{\sf FRM}$ | Repetitive Peak Forward Surge Current | 46 30 | А | T_c =25°C, t_p =10 ms, Half Sine Pulse T_c =110°C, t_p =10 ms, Half Sine Pulse | |
| I _{FSM} | Non-Repetitive Forward Surge Current | 67 59 | А | T_c =25°C, t_p =10 ms, Half Sine Pulse T_c =110°C, t_p =10 ms, Half Sine Pulse | Fig. 8 |
| I _{F,Max} | Non-Repetitive Peak Forward Current | 750 620 | А | T_c =25°C, t_p =10 μ s, Pulse T_c =110°C, t_p =10 μ s, Pulse | Fig. 8 |
| P _{tot} | Power Dissipation | 153 66 | W | T _c =25°C T _c =110°C | Fig. 4 |
| dV/dt | Diode dV/dt ruggedness | 200 | V/ns | V _R =0-960V | |
| ∫i²dt | i²t value | 22.5 17.5 | A²s | $T_c = 25$ °C, $t_p = 10$ ms $T_c = 110$ °C, $t_p = 10$ ms | |
| T _J , T _{stg} | Operating Junction and Storage Temperature | -55 to +175 | °C | | |
| | TO-247 Mounting Torque | 1 8.8 | Nm lbf-in | M3 Screw 6-32 Screw | |







Electrical Characteristics

| Symbol | Parameter | Тур. | Max. | Unit | Test Conditions | Note |
|----------------|---------------------------|-----------------|------------|------|--|--------|
| V _F | Forward Voltage | 1.5 2.2 | 1.8 3 | V | $I_F = 10 \text{ A } T_J = 25^{\circ}\text{C}$ $I_F = 10 \text{ A } T_J = 175^{\circ}\text{C}$ | Fig. 1 |
| I _R | Reverse Current | 30 55 | 250 350 | μΑ | V _R = 1200 V T _J =25°C V _R = 1200 V T _J =175°C | Fig. 2 |
| Q _c | Total Capacitive Charge | 52 | | nC | $V_R = 800 \text{ V, } I_F = 10\text{A}$ $di/dt = 200 \text{ A/}\mu\text{s}$ $T_J = 25^{\circ}\text{C}$ | Fig. 5 |
| С | Total Capacitance | 754 45 38 | | pF | $V_R = 0 \text{ V, } T_J = 25^{\circ}\text{C, } f = 1 \text{ MHz}$ $V_R = 400 \text{ V, } T_J = 25^{\circ}\text{C, } f = 1 \text{ MHz}$ $V_R = 800 \text{ V, } T_J = 25^{\circ}\text{C, } f = 1 \text{ MHz}$ | Fig. 6 |
| E _c | Capacitance Stored Energy | 14.5 | | μJ | V _R = 800 V | Fig. 7 |

Note: This is a majority carrier diode, so there is no reverse recovery charge.

Thermal Characteristics

| Symbol | nbol Parameter | | Unit | Note |
|--------------------|--|------|------|--------|
| $R_{_{\theta JC}}$ | Thermal Resistance from Junction to Case | 0.98 | °C/W | Fig. 9 |

Typical Performance

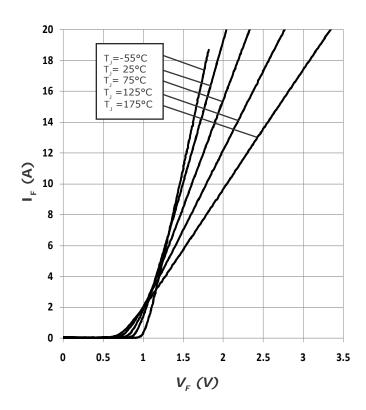


Figure 1. Forward Characteristics

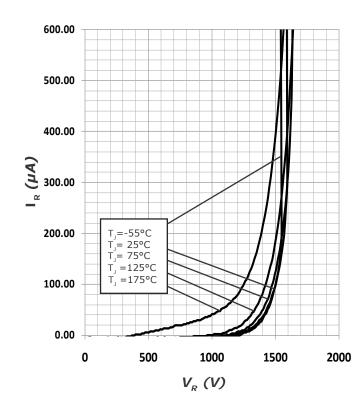
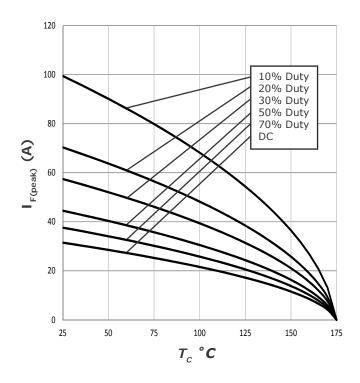


Figure 2. Reverse Characteristics

Typical Performance



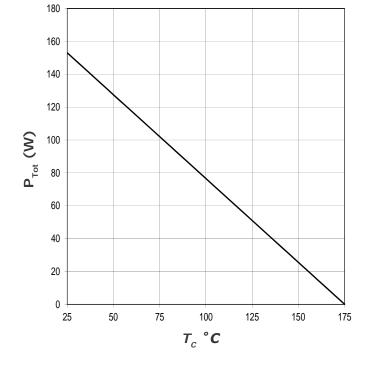


Figure 3. Current Derating

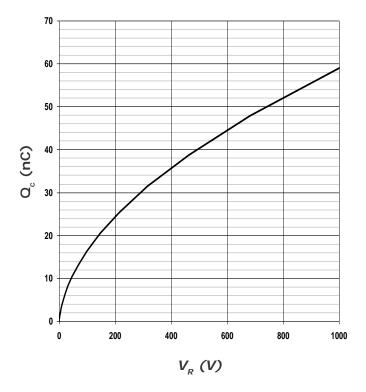


Figure 4. Power Derating

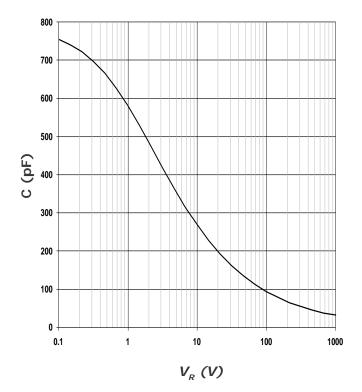
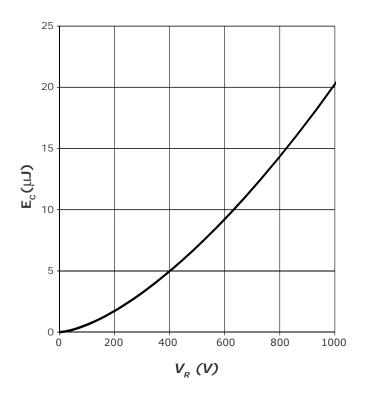


Figure 5. Recovery Charge vs. Reverse Voltage

Figure 6. Capacitance vs. Reverse Voltage



Typical Performance



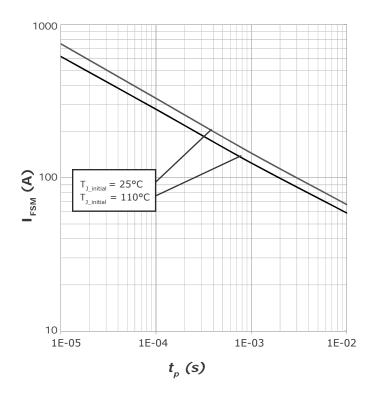


Figure 7. Typical Capacitance Stored Energy

Figure 8. Non-repetitive peak forward surge current versus pulse duration (sinusoidal waveform)

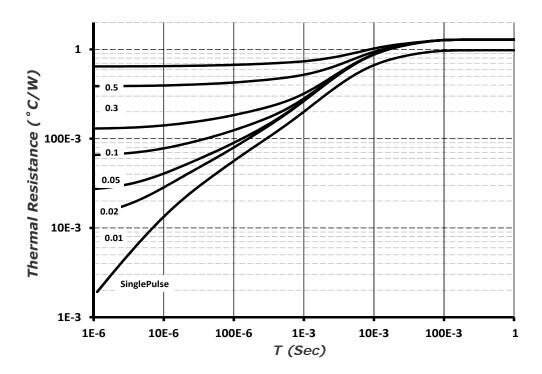


Figure 9. Transient Thermal Impedance

Diode Model

$$\begin{array}{c|c} - & & \\ \hline V_T & & R_T \\ \end{array}$$

$$V_{fT} = V_T + If * R_T$$

$$V_T = 0.98 + (T_J^* - 1.71^*10^{-3})$$

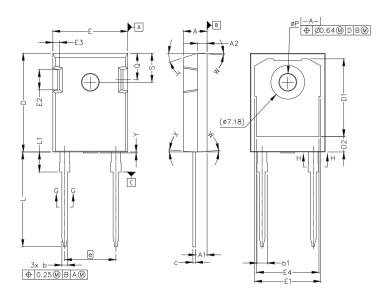
 $R_T = 0.040 + (T_J^* 5.32^*10^{-4})$

Note: T_j = Diode Junction Temperature In Degrees Celsius, valid from 25°C to 175°C



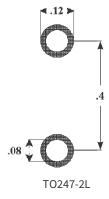
Package Dimensions

Package: TO247-2L All dimensions in mm.



| 0.24 | MILLIM | ETERS | INCHES | | | |
|------|--------|-----------|--------|-------|--|--|
| SYM | MIN | MAX | MIN | MAX | | |
| A | 4.83 | 5.21 | .190 | .205 | | |
| A1 | 2.29 | 2.54 | .090 | .100 | | |
| A2 | 1.91 | 2.16 | .075 | .085 | | |
| b' | 1.07 | 1.28 | .042 | .050 | | |
| b | 1.07 | 1.33 | .042 | .052 | | |
| bl | 1.91 | 2.41 | .075 | .095 | | |
| b2 | 1.91 | 2.16 | .075 | .085 | | |
| c' | 0.55 | 0.65 | .022 | .026 | | |
| с | 0.55 | 0.68 | .022 | .027 | | |
| D | 20.80 | 21.10 | .819 | .831 | | |
| D1 | 16.25 | 17.35 | .640 | .683 | | |
| D2 | 2.86 | 3.16 | .112 | .124 | | |
| Е | 15.75 | 16.13 | .620 | .635 | | |
| El | 13.10 | 14.15 | .516 | .557 | | |
| E2 | 3.68 | 5.10 | .145 | .201 | | |
| E3 | 1.00 | 1.90 | .039 | .075 | | |
| E4 | 12.38 | 13.43 | .487 | .529 | | |
| e | 10.88 | BSC | .4281 | BSC | | |
| L | 19.81 | 20.32 | .780 | .800 | | |
| L1 | 4.10 | 4.40 | .161 | .173 | | |
| φP | 3.51 | 3.65 | .138 | .144 | | |
| Q | 5.49 | 6.00 | .216 | .236 | | |
| S | 6.04 | 6.30 | .238 | .248 | | |
| T | | 17.5° R | EF. | | | |
| W | | 3.5° REF. | | | | |
| X | | 4° REF. | | | | |
| Y | 0 | 0.50 | 0 | 0.020 | | |

Recommended Solder Pad Layout



all units are in inches

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